



JOC305XD5 Series

Rev.A.1.1

DESCRIPTION:

The JOC305XD5 series combine an AlGaAs infrared emitting diode as the emitter which is optically coupled to a monolithic silicon random-phase photo triac in a plastic DIP5 package with different lead forming options. With the robust coplanar double mold structure, JOC305XD5 series provide the most stable isolation feature. The products are widely used in solenoid/valve controls, lighting controls, motor controls, temperature controls, static AC power switches, solid state relays, interfacing microprocessors up to 265 V_{AC} peripherals.

MAIN FEATURES

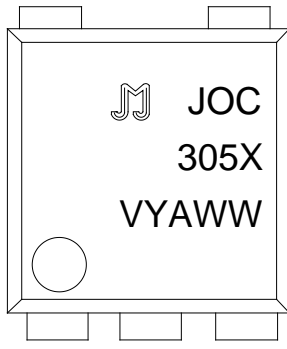
- High isolation 5000 VRMS
- DC input with random-phase photo triac output
- Operating temperature range -55 - Z U - 8 + ') . 8 U . 9 I U S V R O G T I K
- HBM: . ' ! 3 3 3
- CQC approved
- VDE approved
- UL approved

Junction Temperature

T_j

125

ORDERING AND MARKING INFORMATION

MARKING INFORMATION			
		<p>JOC : Company Abbr. 305X: Part Number & Pak V :</p>	
ORDERING INFORMATION			
JOC305X5(Y)(Z)-GV			
<p>JOG- Company Abbr. 305X- Part Number(1/2/3) D5- DIP5 Package Y- Lead Form Option (M/SLSLMNone) Z- Tape and Reel Option (T1) G- Green Option (G or None) V- VDE Option (V or None)</p>			
Packing Quantity			
Option	Quantity	Quantity - Inner box	Quantity -Outer box

Characteristics Curves

FIG.1: Forward Current vs. Ambient Temperature

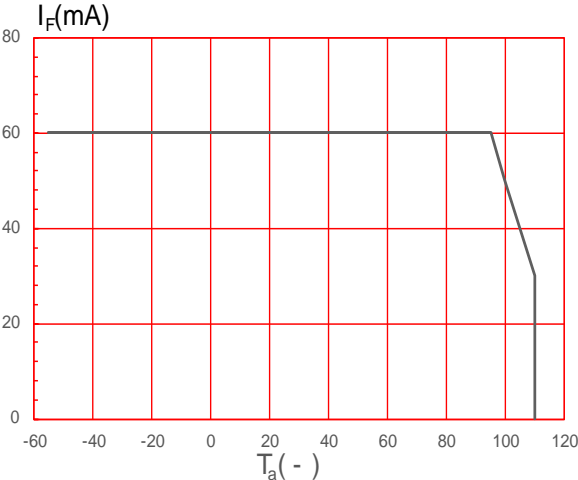


FIG.2: On-state Terminal Current vs. Ambient Temperature

TEST CIRCUITS

FIG.12: Test Circuits of Turn On Time

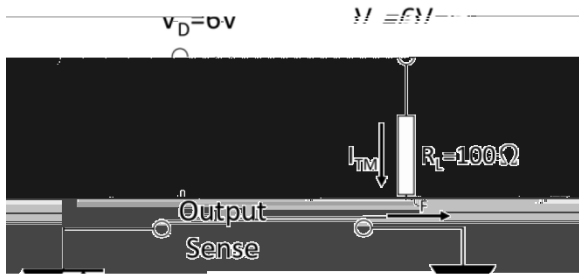


FIG.13: Waveforms of Turn On Time

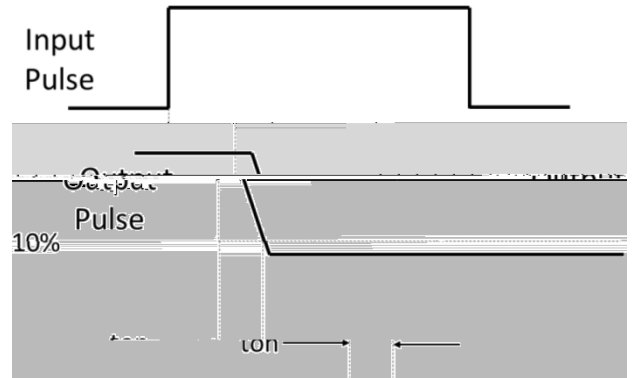


Fig.14: Test Circuits of dV/dt

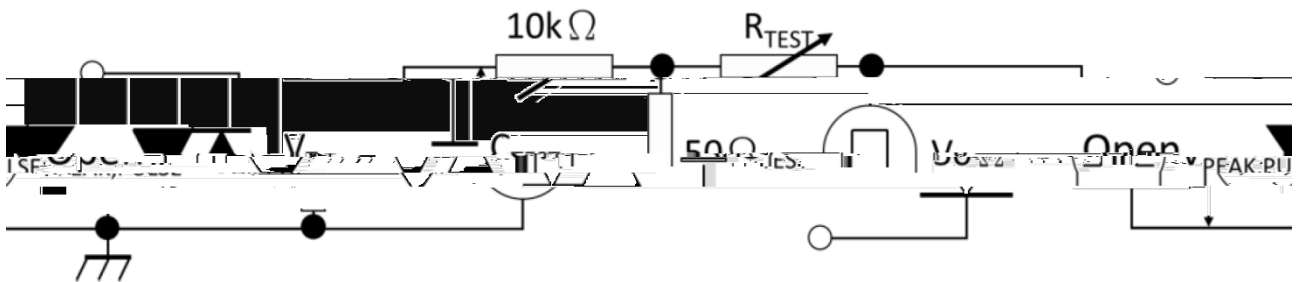
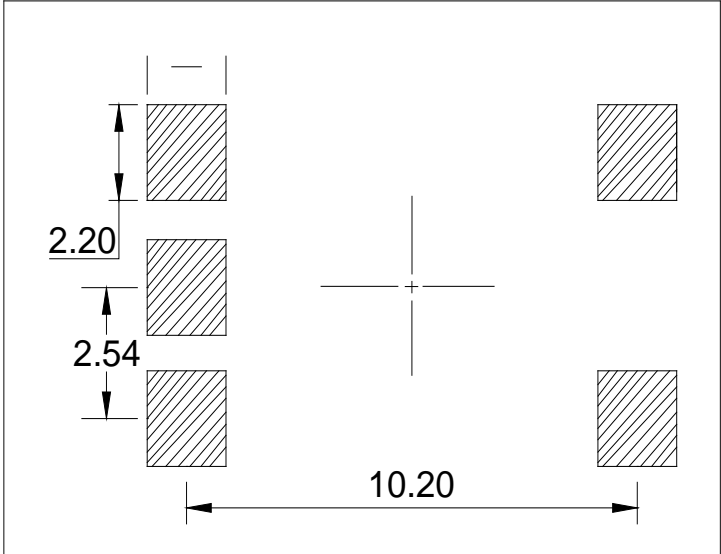


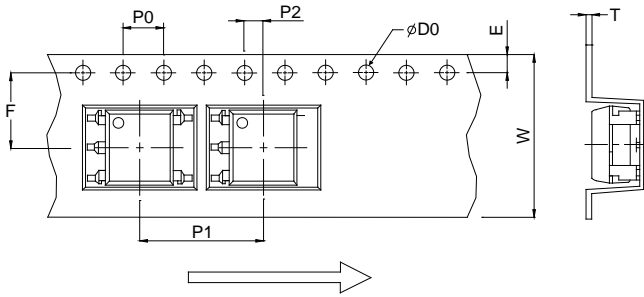
Fig.15: Waveforms of dV/dt



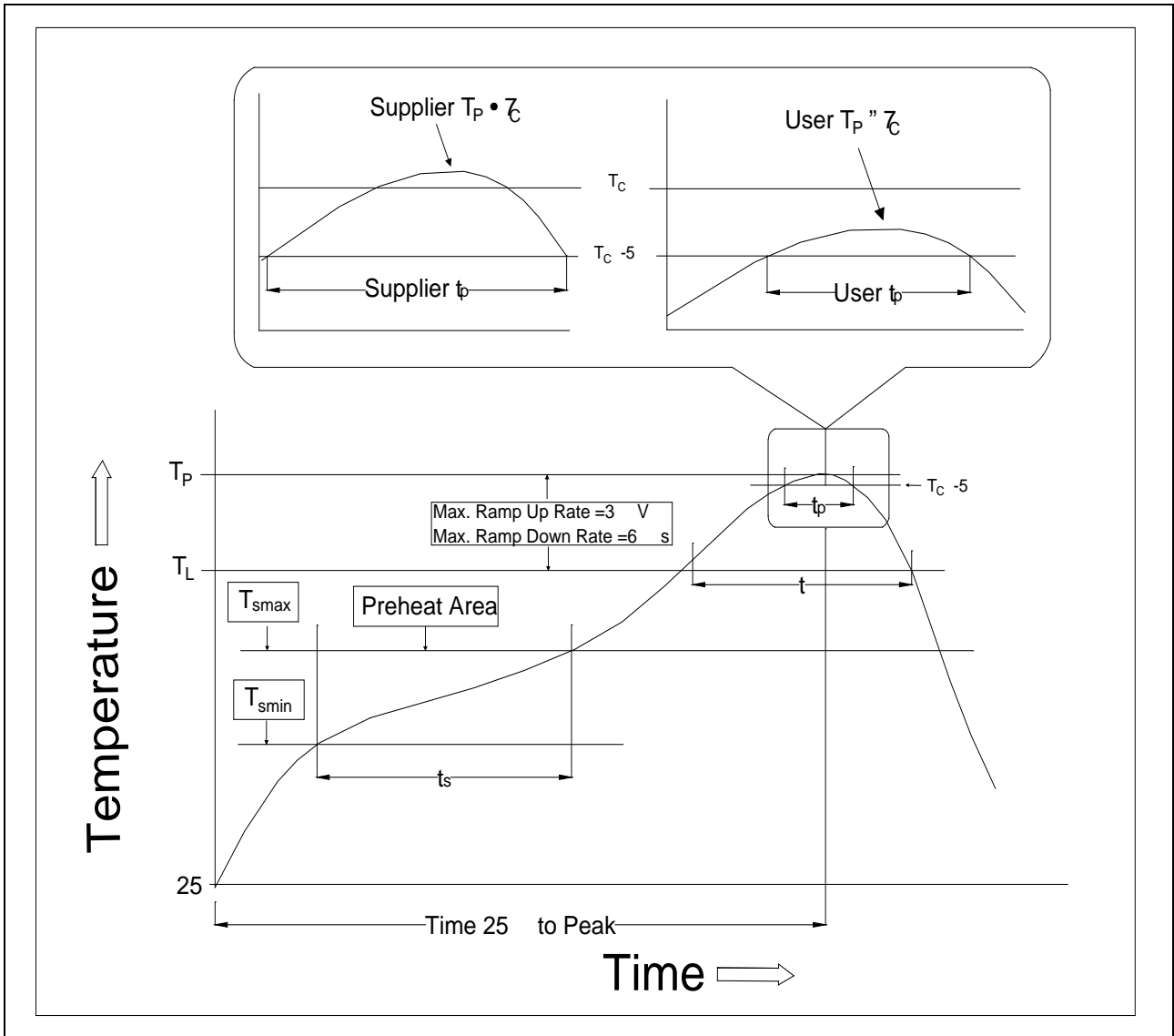
Option SL



CARRIER TAPE SPECIFICATIONS Dimensions in mm unless otherwise stated



REFLOW INFORMATION

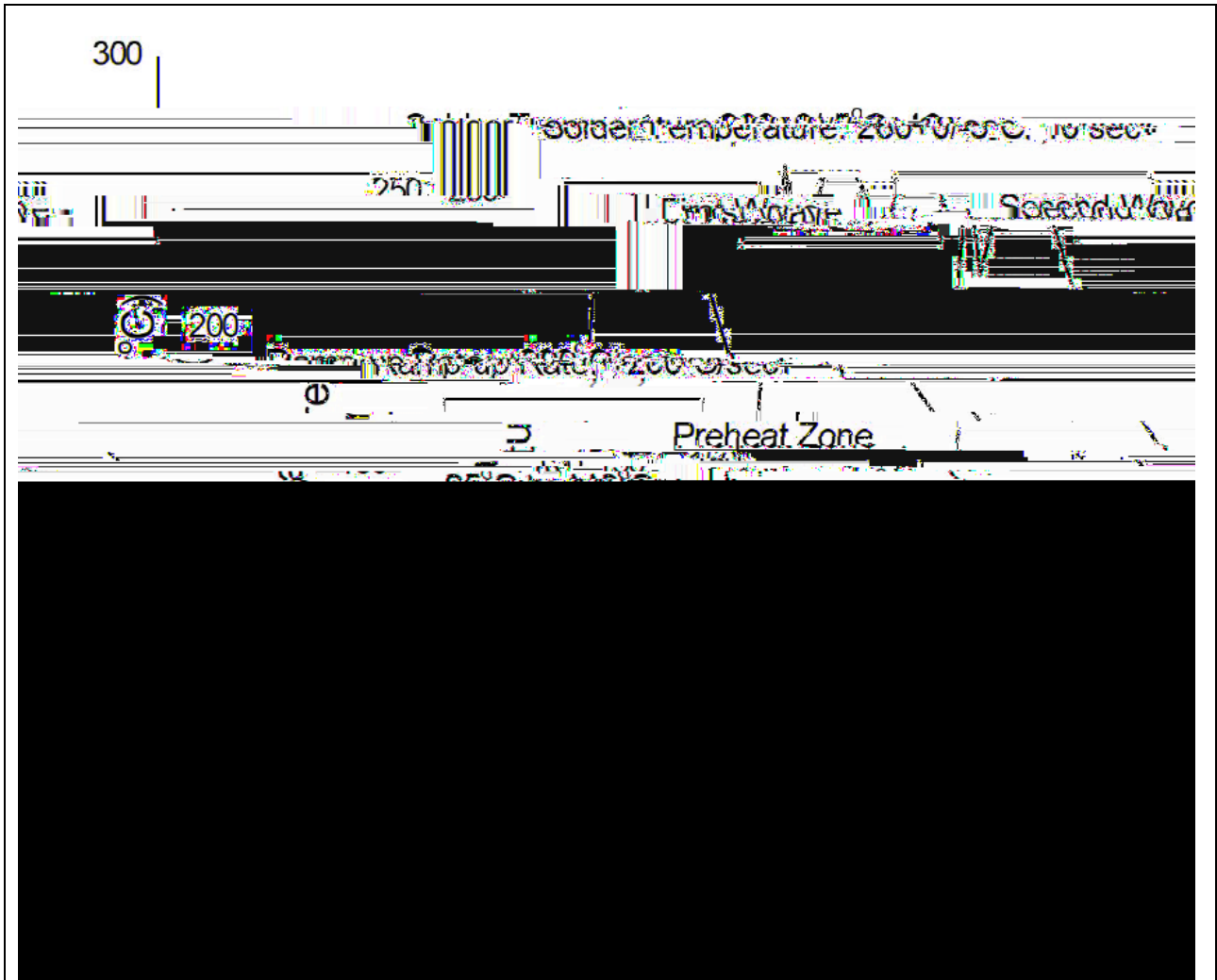


Profile Feature

Sn-Pb Assembly Profile

Pb-Free Assembly Profile

WAVE SOLDERING



HANDSOLDERING BY SOLDERING IRON

Soldering Temperature	360 ± 5
Soldering Time	3s max.

Document Revision History

Date	Revision	Changes
Apr.2, 2025	A.1.0	Last update
Nov.5, 2025	A.1.1	Add S&SLM package

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